

4Gbps Long Wavelength InGaAs PIN PD

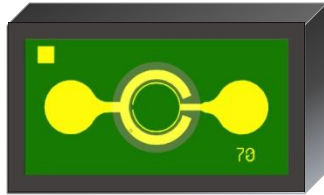
P/N: DO039_70um_B1



Known Good Die

DATASHEET

Introduction



This product is a high-performance front side illuminated InGaAs PIN photodiode chip that features low capacitance, high responsivity, low dark current and excellent reliability. This product has a large 70 μ m detection window, and is intended primary to be integrated with a pre-amplifier in a hermetic TO package, designed to meet performance requirements for data rates up to 4.25Gbps data communication over single-mode optical fiber at 1200nm to 1600nm.

Key Features

- Mesa structure with GCS proprietary epi design and process technologies
- 70 μ m optical detection window for easy optical alignment
- Front-sided dumbbell contact pads for versatile wire bonding
- Excellent low dark current and capacitance
- -40C to 85C operation range
- Highly robust 4" IC wafer fab with fast cycle-time
- Deliverable in GCS Known Good Die™ with 100% testing and inspection
- RoHS compliant

Applications

- SR/LR optical network
- Gigabit Ethernet
- 4G Fiber Channel
- SONET/SDH OC-48
- ATM

SPECIFICATIONS (T=25C°)

	Conditions	Min.	Typical	Max.	Unit	Notes
Bandwidth	-5V		5	-	GHz	
Wavelength range		910	1310/1550	1650	nm	
Capacitance	-5 V		0.4	0.45	pF	
Responsivity	@1310 nm	0.8	0.9	-	A/W	
Dark current	-5V	-	0.5	5	nA	
Reverse breakdown	-20V			1	μ A	

Absolute Maximum Rating

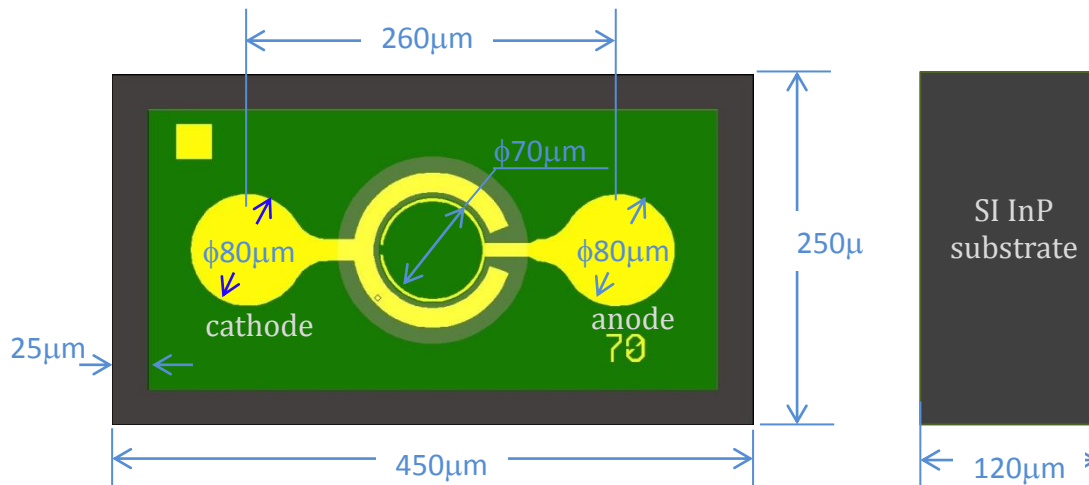
Parameter	Rating
Operating Temperature	-40C to 85C
Storage Temperature	-40C to 125C
Soldering Temperature	320C / 5 sec



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Dimensions

	Conditions	Min.	Typical	Max.	Unit	Notes
Detection window			70		μm	
Bonding pad size			80		μm	for both p- and n- pads
Metal height of bond pad		1.4	1.6	-	μm	Au metal
Die height		110	120	130	μm	
Die width		240	250	260	μm	
Die length		440	450	460	μm	



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Attention: InP brittle material and electrostatic sensitive device, observe precaution for handling.

Contact Information

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About GCS: GCS has a long history manufacturing and shipping both GaAs and InGaAs based photo diodes since 2000. Our state of art manufacturing facility is located in Torrance, California, and has about 10,000 square feet of fab space with a capability of about 1200 4-inch wafers per month and expandable to 2000 wafers per month. GCS as a world-class semiconductor device manufacturer has been delivering a total of over 30 million photo diodes with various date rates and applications used for optical communications, which have been deployed in field by top tier optical transceiver companies worldwide.



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